

Product Brief

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General Description

This specification provides a general guideline on the performance and the integration of the Wi2Wi Inc. Global Navigation Satellite System Module Solution. This new solution is optimised to enable highly accurate location positioning by supporting concurrent GPS, GLONASS, and QZSS (Galileo Ready). The new solder-down module, based on SiRF Star V Chipset is targeted to assist companies to easily integrate GNSS functionally into their products. This is accomplished by reducing their development times and cost by using a complete, small form factor, low power, ready to integrate GNSS Receiver System Solution.

Features

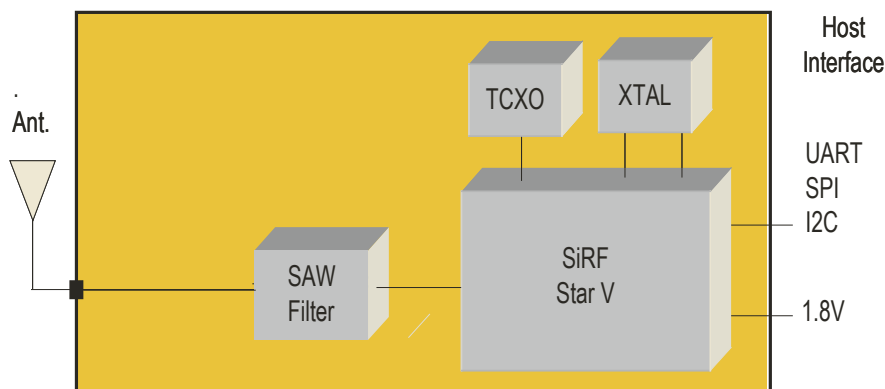
- GNSS technology based upon by the CSR/SiRF™ SiRFStar V™
- Concurrent tracking of GPS, GLONASS, and QZSS
- Compact design for easy integration:
7.0mm x 7.0mm x 2.0mm
- Ultra-low power consumption
- 50Ω Antenna Launch
- SBAS (WAAS or ENGOS) support
- Single 1.8 VDC supply input
- Format Selectable Output Data: NMEA and OSP (SiRFBinary™)
- I2C interface support for alternate Host or sensor support like Compass or Accelerometer for Dead Reckoning applications
- RoHS Compliant

Applications

- Personal Navigation Devices (PNDs)
- Mobile Internet Devices
- Smart Phones
- Gaming Systems
- Asset Tracking
- Personnel Locators
- UAVs
- Personal Digital Assistants (PDAs)
- POS Terminals
- Logistics Management Terminals

Target Specifications

- Package Dimensions
7.0mm(L) x 7.0mm(W) x 2.0mm(H)
- Input Power
Supply Voltage : 1.8VDC
Peak Current : 64mA
- Temperature Range
-40° C to + 85° C
- Input/Output
UART, I2C, SPI
- TTFF (-130 dBm)
Hot start <1 s
Warm start <30 s
Cold start <35 s
- Sensitivity
Acquisition (GPS -146 dBm)
Tracking (GPS -162 dBm,
GLONASS -165 dBm)
Navigation (GPS -162 dBm,
GLONASS -158 dBm)



The preliminary specification is intended for advance information only, and is subject to change without notification.